



PRODUCT DATA SHEET



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Datasheet



Resources

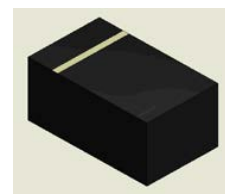


Samples

Please note: Please check the JINGAO Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.jg-semi.cn. Please email any questions regarding the system integration to JINGAO_questions@jgsemi.com.

Features

- Low forward voltage
- Thin & leadless package for space saving
- Pb free version, RoHS compliant,
and Halogen free


DFN1006(0402)

Mechanical Characteristics

- Case: DFN1006(0402) mold package
- Terminal: Sn/Au plated, solderable per

MIL-STD-750, method 2026



Maximum Rating And Electrical Characteristics (at Ta=25°C unless otherwise noted)

| Parameter | Condition | Symbol | Min | Typ | Max | Unit |
|---------------------------------|--|------------------|-----|-----|----------------------|------|
| Repetitive peak reverse voltage | | VRRM | | | 35 | V |
| Reverse voltage | | VR | | | 30 | V |
| Average forward current | | Io | | | 100 | mA |
| Forward current surge peak | 8.3 ms single half sine-wave superimposed on rate load (JEDEC method) | IFSM | | | 1 | A |
| Storage/Operation temperature | | T _{Sgt} | -40 | | 125 | °C |
| Junction temperature | | T _J | | | 125 | °C |
| Forward voltage | IF1=10mA IF2=20mA IF3=100mA | VF | | | 0.29 0.30 0.40 | V |
| Reverse current | VR=30V | IR | | | 30 | uA |

Typical Characteristics

Fig.1-forward characteristics

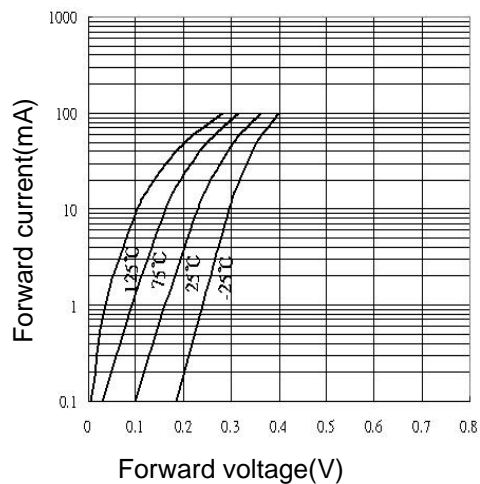


Fig.2-Reverse characteristics

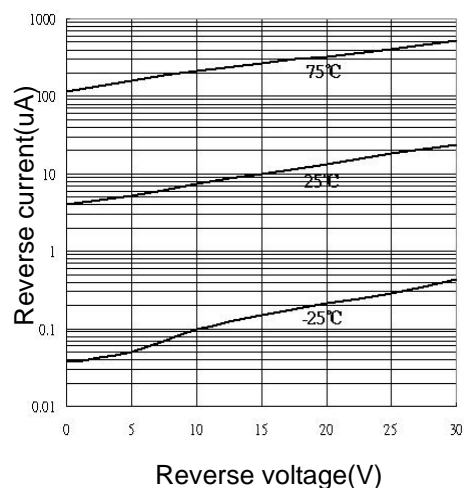


Fig.3 - Capacitance between terminals characteristics

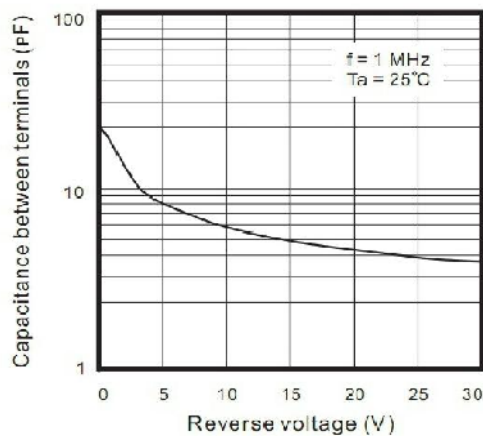


Fig.4 - Current derating curve

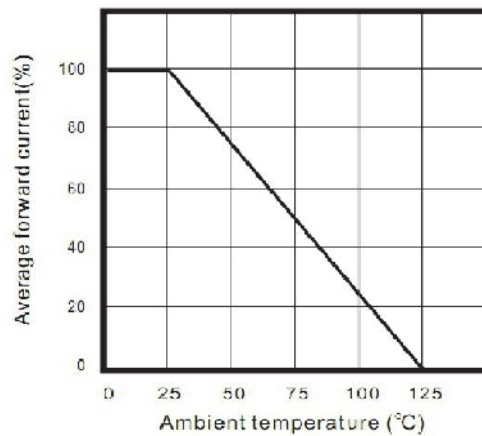


Fig. 5 - VF Dispersion map

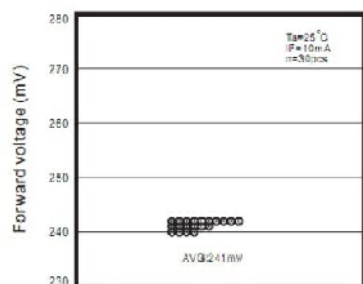


Fig. 6 - IR Dispersion map

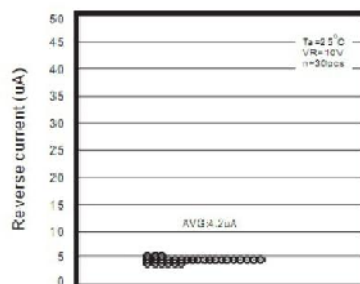
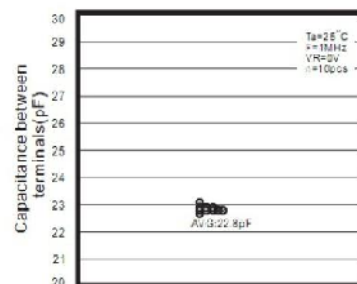
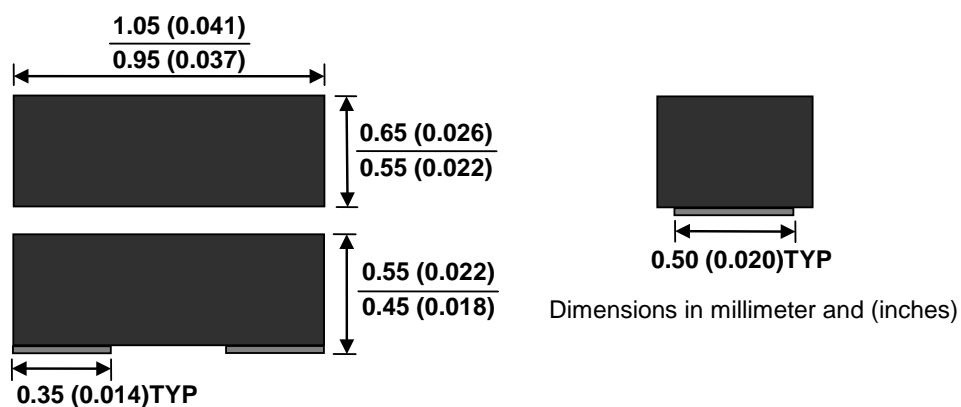
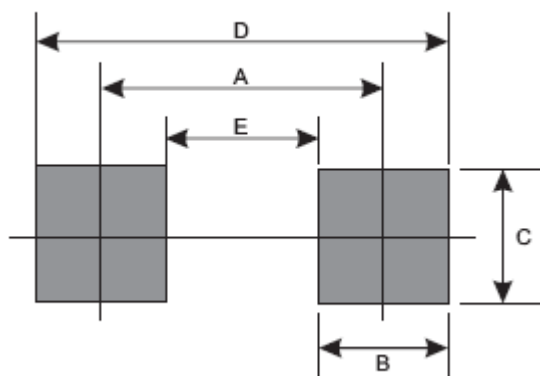


Fig. 7 - CT Dispersion map



DFN1006(0402)

Recommended Soldering Footprint

Reflow Soldering

| Product Size | Dimension/ mm | | | | |
|--------------|---------------|--------|--------|--------|--------|
| | A | B | C | D | E |
| DFN1006 | 0.750 | 0.500 | 0.700 | 1.250 | 0.250 |
| | 0.030" | 0.020" | 0.028" | 0.049" | 0.010" |

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